

Macro-model of Spin-Transfer Torque based Magnetic Tunnel Junction device for hybrid Magnetic-CMOS design



Weisheng Zhao, Eric Belhaire, Quentin Mistral, Claude Chappert

Institut d' Electronique Fondamentale
CNRS / University of Paris South, France

Virgile Javerliac, Bernard Dieny
SPINTEC, CEA, France

Elsa Nicolle
STMicroelectronics Grenoble, France

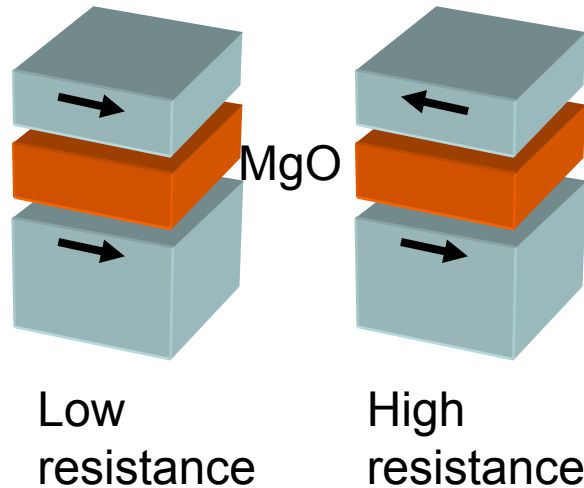
IEEE BMAS-- San Jose, California, USA
14-15/09/2006



- ❖ **Hybrid Magnetic-CMOS design**
 - MRAM (Magnetic RAM)
 - Applications : Magnetic logic, FPGAs,
- ❖ **STT (Spin-Transfer Torque) based MRAM**
 - STT based Magnetic Tunnel Junction (MTJ) introduction
 - Model presentation : three main equations
- ❖ **Electrical Macro model development and Simulations**
- ❖ **Conclusion and perspective**

MRAM Introduction

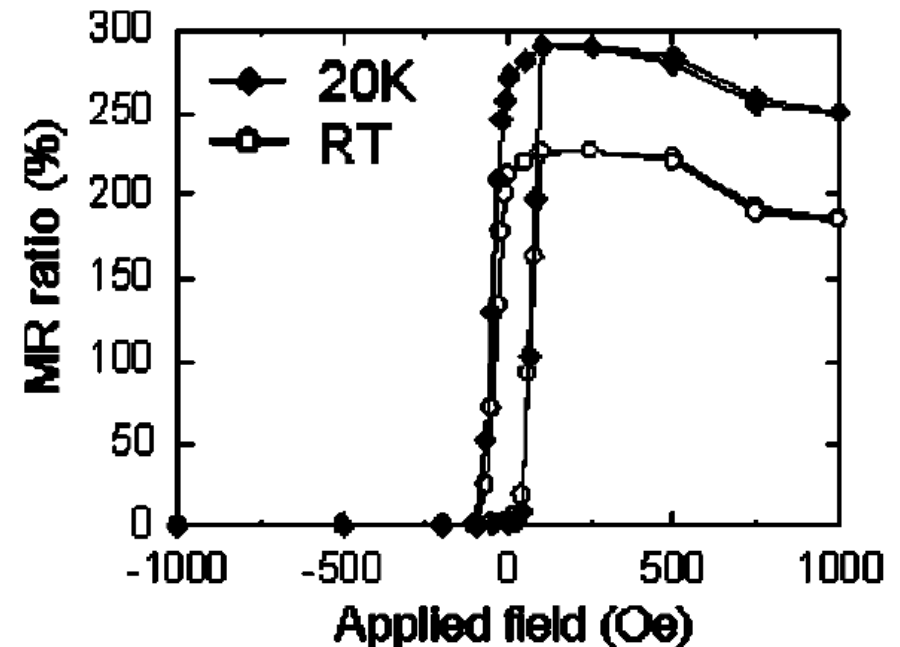
Magnetic Tunnel Junction



$$TMR = \frac{R_{high} - R_{low}}{R_{low}}$$

MR curves of CoFeB/MgO/CoFeB MTJs evaluated

Djayaprawira et al. [APL'05]

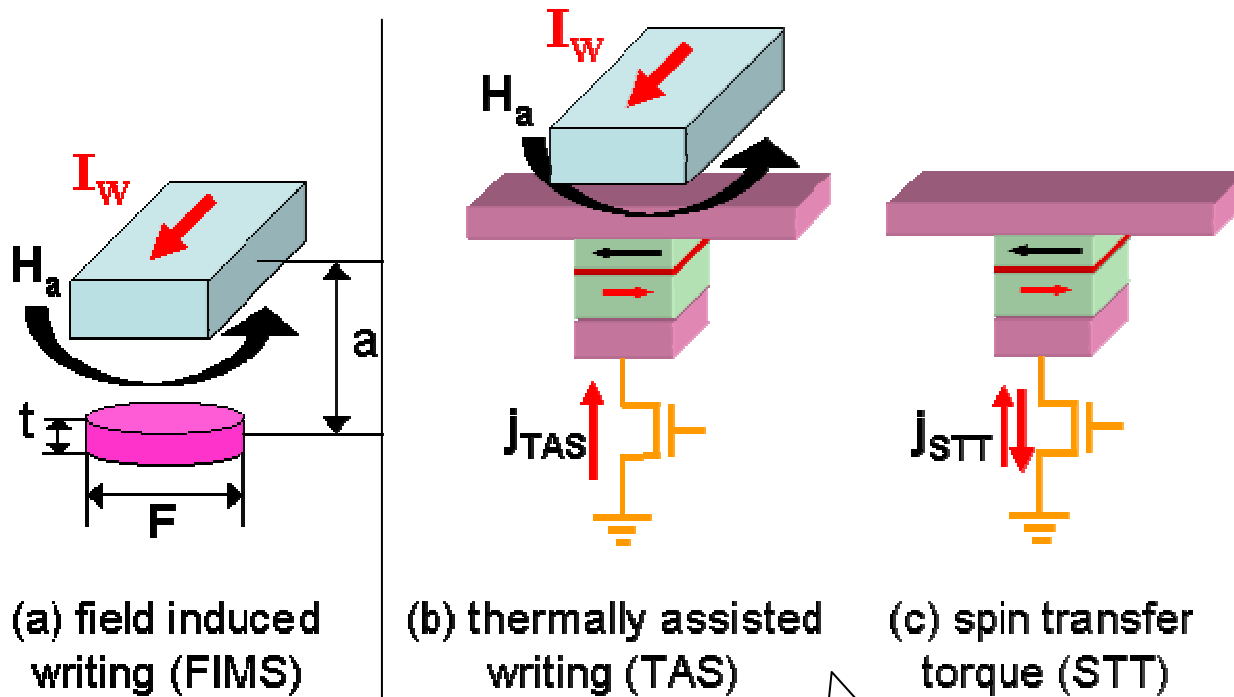


TMR (Tunnel Magnetoresistance ratio)

- 70% with Al_xO_y barrier
- 230% with MgO barrier

Hybrid Magnetic-CMOS design

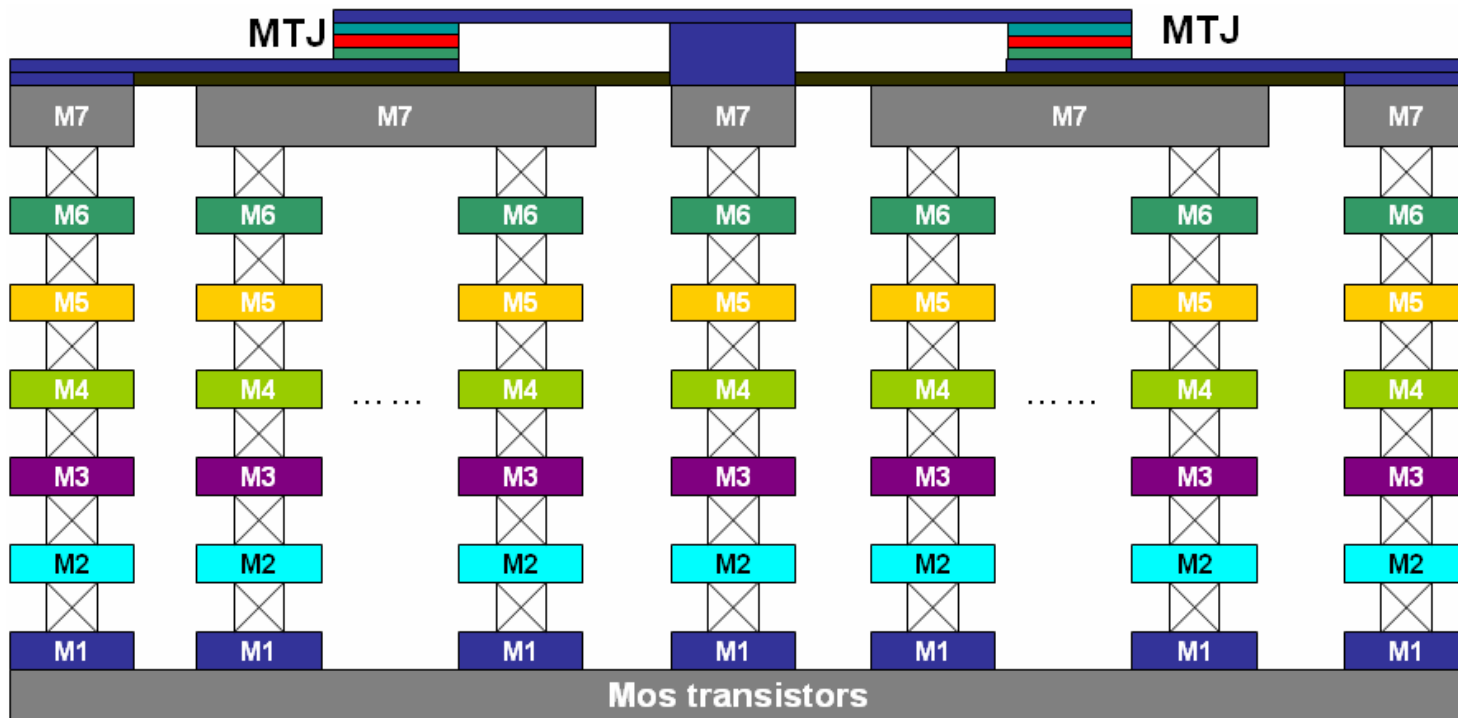
Writing a MTJ : 3 technologies



- 1st generation MRAM
 - Two High currents required
 - High power dissipation
 - large width transistors
- $\approx 10 \text{ à } 20 \text{ mA}$**

- 2nd generation
- TAS $\approx 1 \text{ mA}$
- STT $\approx 120 \text{ }\mu\text{A}$

Hybrid Magnetic-CMOS design



MTJs are implemented on top of the CMOS layers

Advantages

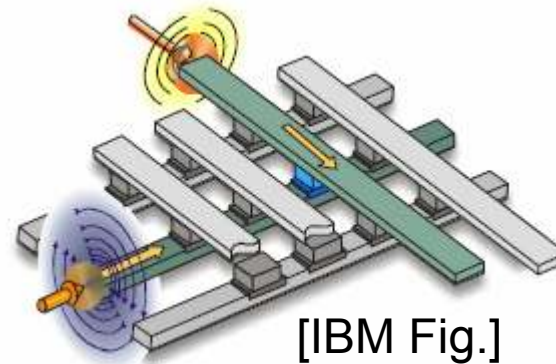
- Bring non-volatility property to CMOS
- High reading speed (10-20ns)
- High writing speed (<1ns)
- Large retention time more than 10 years
- High density (MTJ : 113nm*75nm)
- More than 10^{12} re-programming cycles

Constraints

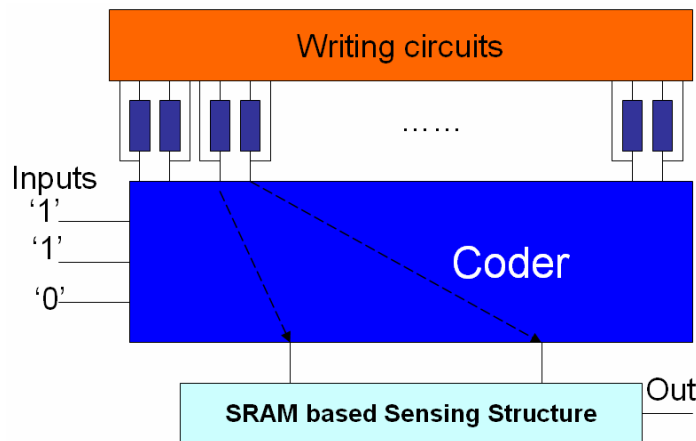
- More fabrication masks than standard CMOS
- Power dissipation with 1st gen writing techno.

Hybrid Magnetic-CMOS design APPLICATIONS

- MRAM memory:
IBM, Freescale, ...

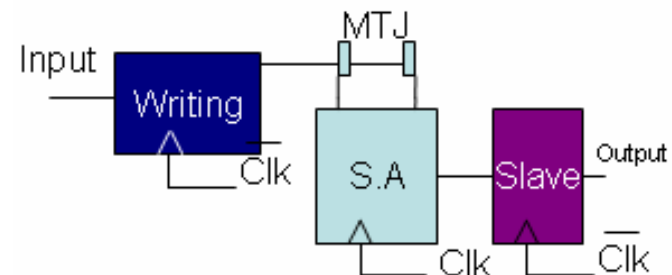


- Secured FPGA:



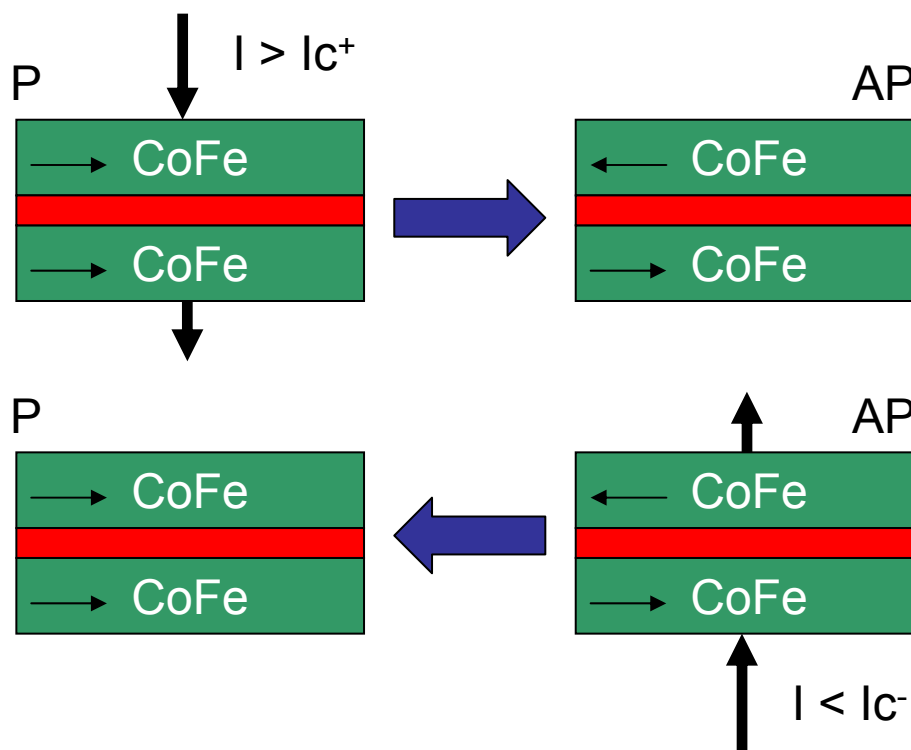
3-input LUT

with non-volatile configuration
(will be presented at ICSICT06, Shanghai)



Non volatile FLIP-FLOP
(presented at ICICDT06, Italy)

STT (Spin-Transfer Torque) based MTJ

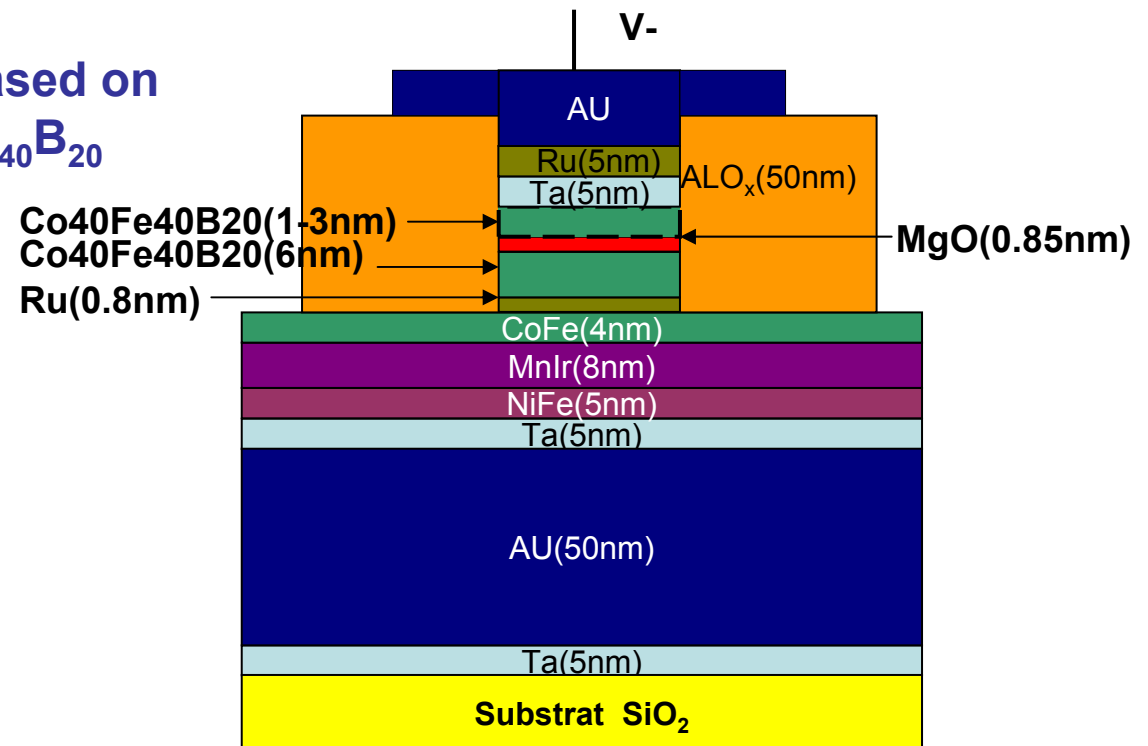


The MTJ state changes :

- from Parallel (P) to Anti-parallel (AP) if current density $I > I_c^+$
- from AP to P if $I < -I_c^-$

STT (Spin-Transfer Torque) based MTJ

The modeled MTJ is based on $\text{Co}_{40}\text{Fe}_{40}\text{B}_{20}/\text{MgO}/\text{Co}_{40}\text{Fe}_{40}\text{B}_{20}$



3 equation sets are implemented in the behavioral model :

1. Slonczewski critical model
2. Brinkman resistance model
3. TMR effect bias-voltage dependence model



STT (Spin-Transfer Torque) based MTJ

1st eq set : Slonczewski model

$$J_c = J_{c0} \left\{ 1 - \left(\frac{k_B \times T}{E} \right) \ln(\tau_m \times f_0) \right\}$$

$$J_{c0} = \alpha \times \gamma \times e \times M_s \times t \times (H_{ext} \pm H_{ani} \pm H_d / 2) / u_B \times g$$

$$E = \frac{M_s \times V \times H_c}{2}$$

$$g = \left[-4 + (P^{-1/2} + P^{1/2}) \times (3 + \cos \theta) / 4 \right]^{-1}$$

Hext: the external field: -190e

Hani: the in-plane uniaxial magnetic anisotropy field 100 Oe

Hd: the out-of-plane magnetic anisotropy induced by the demagnetization field 13000 Oe

ζ_m : the measurement time 1s

f_0 : the attempt frequency 109Hz

k_B : Boltzmann constant, $1.38 \times 10^{-23} \text{ J/K}$

u_B : Bohr magneton constant, $9.27 \times 10^{-28} \text{ J/Oe}$

M_s : 1.3 T (CoFe) = 13000 Oe

H_c : coercive field

α : Gilbert damping coefficient 0,01

γ : gyromagnetic constant = $221000/2 \times \pi$

e : An elementary charge $1.60 \times 10^{-19} \text{ C}$

Parameters:

• **t**: height of the free layer (1-3nm)

• **Θ** : parallel: 0 and anti-parallel: π

• **V**: volume of the free layer ($80 \times 240 \text{ nm}^2 \times t$)



STT (Spin-Transfer Torque) based MTJ

2nd eq set : Brinkman conductance model

$$\frac{G(V)}{G(0)} = 1 - \left(\frac{A_0 \Delta \varphi}{16 \bar{\varphi}^{-3/2}} \right) eV + \left(\frac{9}{128} \frac{A_0^2}{\bar{\varphi}} \right) (eV)^2$$

$$G(0) = 3.16 \times 10^{10} \times \bar{\varphi}^{-1/2} \frac{\exp(-1.025 \times d \times \bar{\varphi}^{-1/2})}{d}$$

$$A_0 = \frac{4 \times (2m)^{1/2} \times d}{3 \times \bar{h}}$$



$$R(0) = \frac{tox}{223.76 \times \bar{\varphi}^{-1/2} \times surface} \times \exp(1.025 \times tox \times \bar{\varphi}^{-1/2})$$

$$R(V) = \frac{R(0)}{1 + \left(\frac{tox^2 \times e^2 \times m}{4 \times \bar{h}^{-2} \times \bar{\varphi}} \right) \times V^2}$$

Constants:

m: the electron mass 9.1×10^{-31}

$\Delta \varphi$: 0 (The barrier is symmetric)

\bar{h} : Planck's constant: 1.0545×10^{-34}

$\bar{\varphi}$: The potential barrier height 0.4 (for MgO [2]), 2 (for Al₂O₃)

Parameters:

tox: height of barrier in MTJ

surface: surface of the MTJ (rectangle or ellipse)

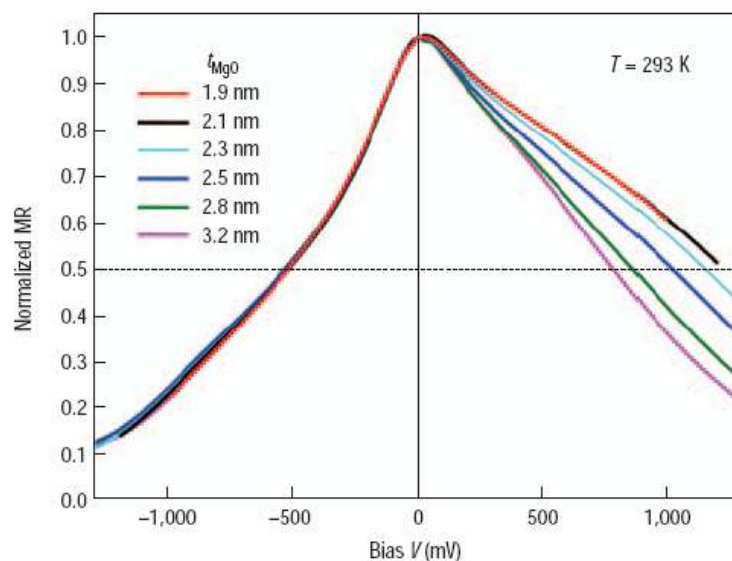
STT (Spin-Transfer Torque) based MTJ

3rd eq set : TMR bias-voltage dependence model

$$TMR_{real} = \frac{TMR(0)}{1 + \frac{V^2}{V_h^2}}$$

TMR (0): Resistance Ratio between low and high resistance with 0V bias-voltage.

V_h: the bias voltage where TMR_{real} = 0.5 * TMR (0)



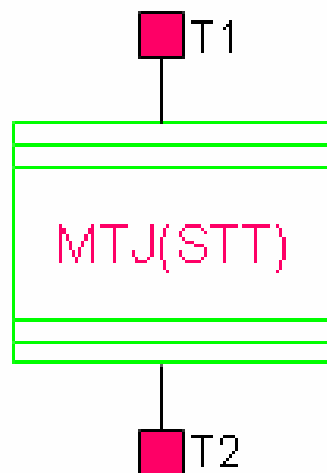
Relation between bias voltage V and the normalized MR ratio at room temperature

Yuasa et al, Nature Materials

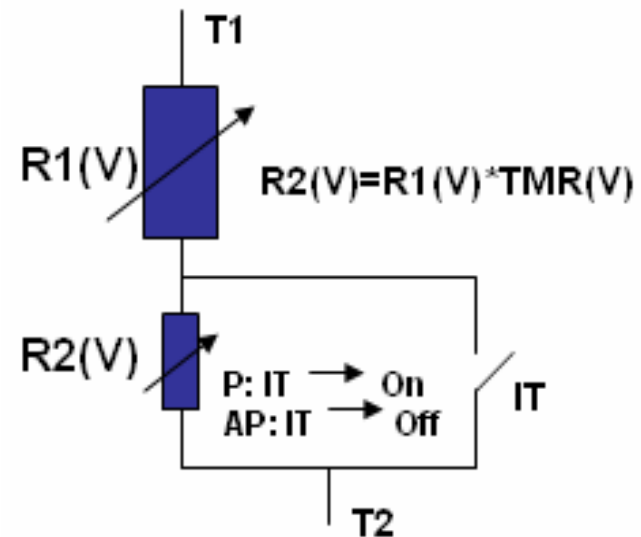
Electrical Macro model developed and Simulations

Simulation Environment:

1. STmicroelectronics 90nm design kit
2. Cadence spectre simulator
3. Verilog-A language

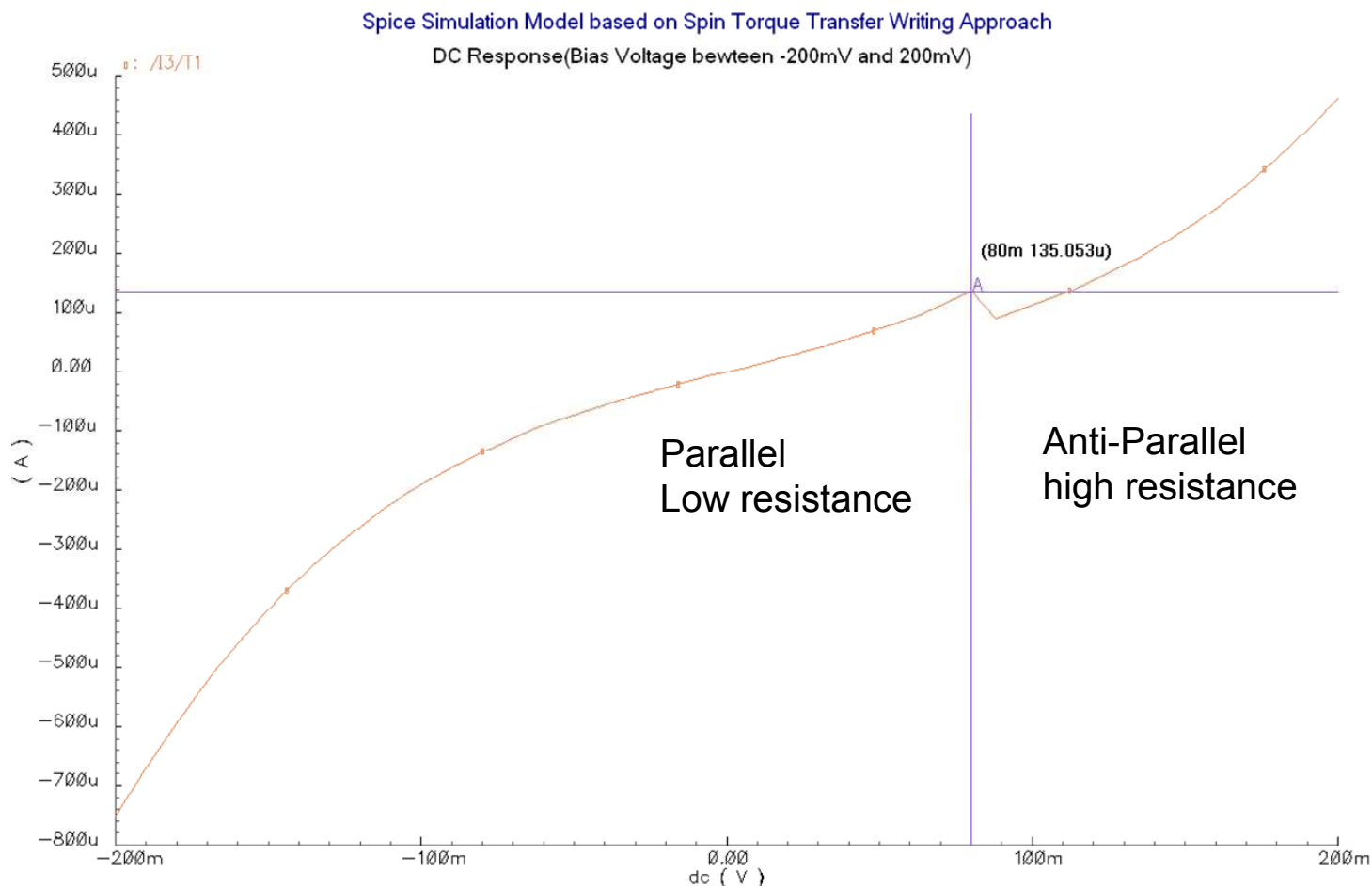


Simulation model symbol



Resistance equivalent circuit

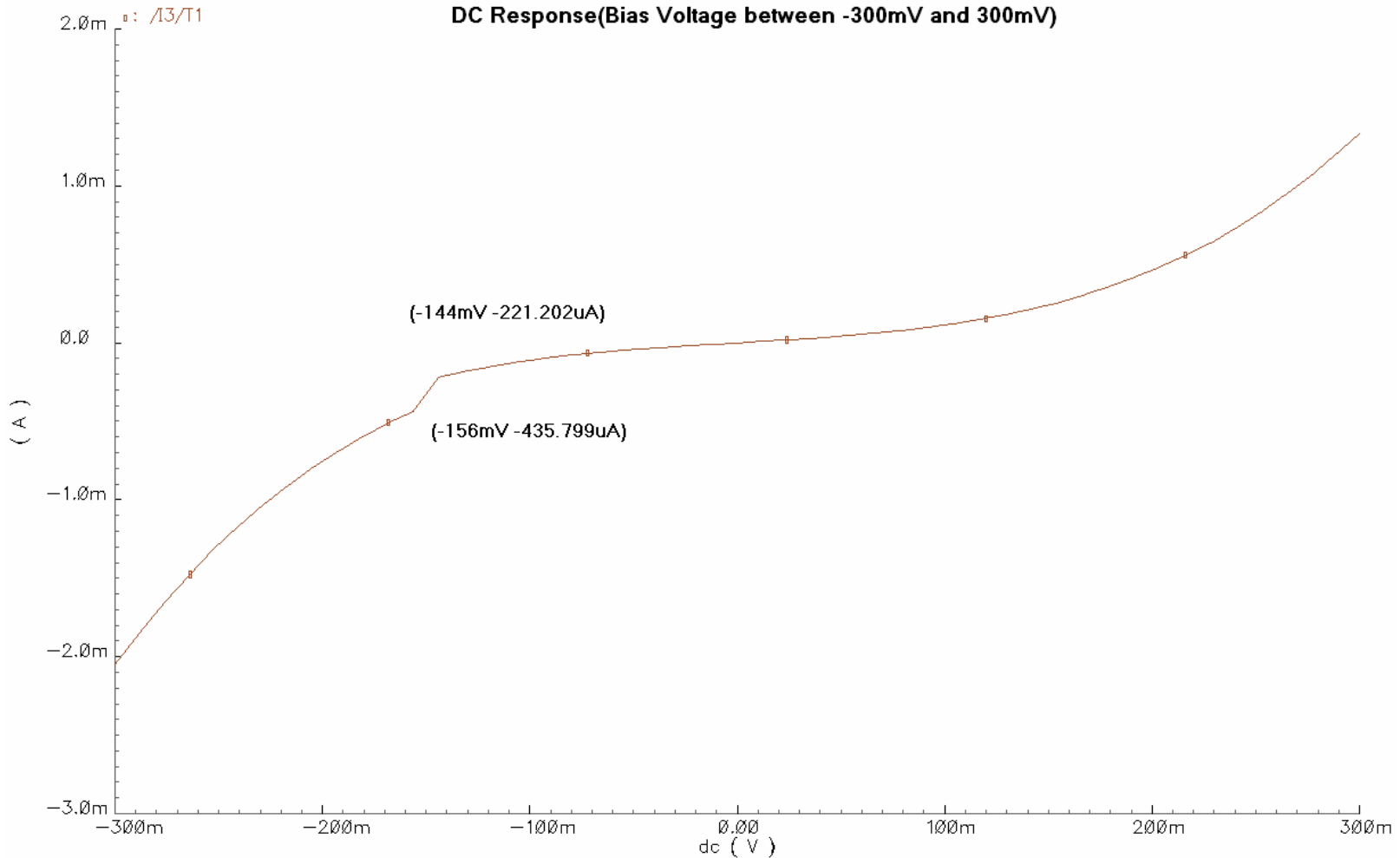
Electrical Macro model developed and Simulations



MTJ DC simulation :
the threshold current is about 135 uA
and the threshold voltage is about 80mV

Electrical Macro model developed and Simulations

Spice Simulation Model based on Spin Torque Transfer Writing Approach
DC Response(Bias Voltage between -300mV and 300mV)

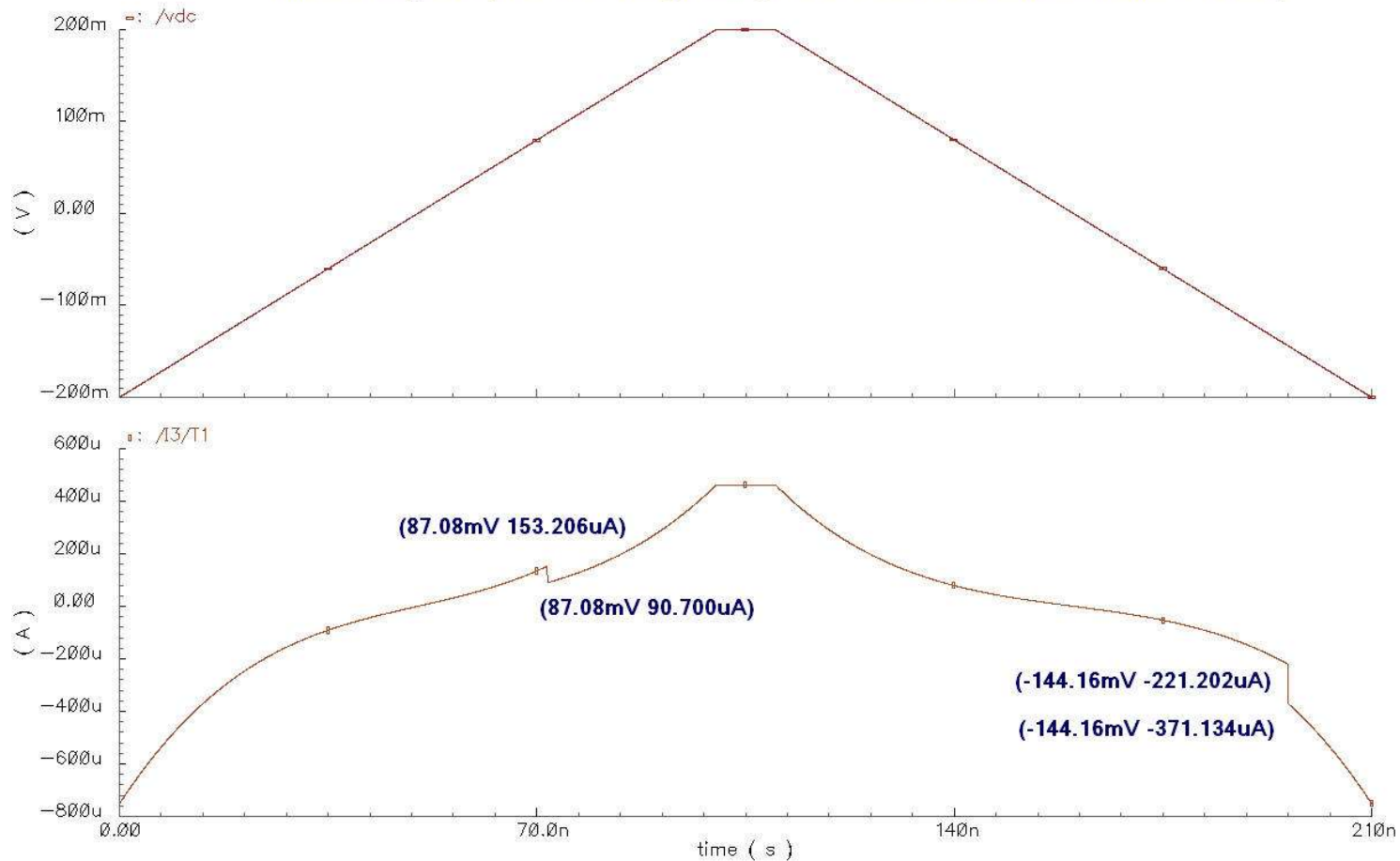


MTJ DC simulation:
the threshold current is about -221uA
and the threshold voltage is about -156mV



Electrical Macro model developed and Simulations

Spice Simulation Model based on Spin Torque Transfer Writing Approach
Transient Response (210ns Bias Voltage changes from -200mV to 200mV and returns to -200mV)



MTJ transient simulation :
the threshold current is about
153uA for parallel and -221uA for anti-parallel



Conclusions and perspectives

- The model has been developed to simulate hybrid MTJ/CMOS architectures
- The model is based on next generation Spin-Transfer Torque (STT) writing technique
- The current model is in the static writing mode and is sufficient for the magnetic FPGA simulation
- The dynamical switching behavior will be presented in the future.
- The main applications are the design of MRAM and Magnetic FPGA

